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FAIRCHILD SEMICONDUCTOR®

August 2024

# FQS4901

## N-Channel QFET® MOSFET

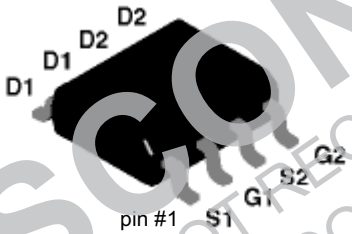
### 400 V, 0.45 A, 4.2 Ω

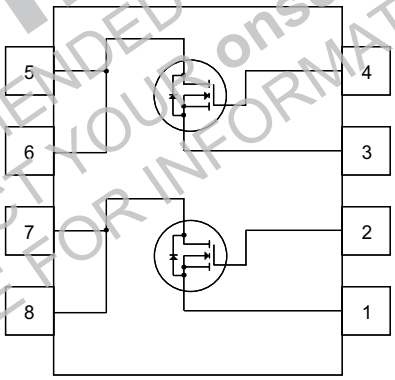
## Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

## Features

- 0.45 A, 400 V, $R_{DS(on)}$=4.2 Ω(Max.)@$V_{GS}$=10 V, $I_D$=0.225 A
- Low Gate Charge (Typ. 5.8 nC)
- Low $C_{rss}$ (Typ. 5 pF)
- 100% Avalanche Tested






## Absolute Maximum Ratings

$T_A$ = 25°C unless otherwise noted

| Symbol | Parameter | | FQS4901 | Unit |
|---|---|---|---|---|
| $V_{DSS}$ | Drain-Source Voltage | | 400 | V |
| $I_D$ | Drain Current - Continuous ($T_A$ = 25°C) | | 0.45 | A |
| | - Continuous ($T_A$ = 70°C) | | 0.285 | A |
| $I_{DM}$ | Drain Curent - Pulsed | (Note 1) | 1.8 | A |
| $V_{GSS}$ | Gate-Source Voltage | | ± 25 | V |
| dv/dt | Peak Diode Recovery dv/dt | (Note 2) | 4.5 | V/ns |
| $P_D$ | Power Dissipation ($T_A$ = 25°C) | | 2.0 | W |
| | ($T_A$ = 70°C) | | 1.3 | W |
| $T_J$, $T_{STG}$ | Operating and Storage Temperature Range | | -55 to +150 | °C |

## Thermal Characteristics

| Symbol | Parameter | Typ | Max | Unit |
|---|---|---|---|---|
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | -- | 62.5 | °C/W |

## Electrical Characteristics

$T_A$ = 25°C unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| **Off Characteristics** | | | | | | |
| $BV_{DSS}$ | Drain-Source Breakdown Voltage | $V_{GS}$ = 0 V, $I_D$ = 250 µA | 400 | -- | -- | V |
| $\Delta BV_{DSS}$ / $\Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D$ = 250 µA, Referenced to 25°C | -- | 0.42 | -- | V/°C |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | $V_{DS}$ = 400 V, $V_{GS}$ = 0 V | -- | -- | 1 | µA |
| | | $V_{DS}$ = 320 V, $T_C$ = 125°C | -- | -- | 10 | µA |
| $I_{GSSF}$ | Gate-Body Leakage Current, Forward | $V_{GS}$ = 25 V, $V_{DS}$ = 0 V | -- | -- | 100 | nA |
| $I_{GSSR}$ | Gate-Body Leakage Current, Reverse | $V_{GS}$ = -25 V, $V_{DS}$ = 0 V | -- | -- | -100 | nA |
| **On Characteristics** | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 µA | 2.0 | -- | 4.0 | V |
| $R_{DS(on)}$ | Static Drain-Source On-Resistance | $V_{GS}$ = 10 V, $I_D$ = 0.225 A | -- | 3.2 | 4.2 | Ω |
| $g_{FS}$ | Forward Transconductance | $V_{DS}$ = 35 V, $I_D$ = 0.225 A (Note 3) | -- | 0.283 | -- | S |
| **Dynamic Characteristics** | | | | | | |
| $C_{iss}$ | Input Capacitance | $V_{DS}$ = 25 V, $V_{GS}$ = 0 V, f = 1.0 MHz | -- | 160 | 210 | pF |
| $C_{oss}$ | Output Capacitance | | -- | 30 | 40 | pF |
| $C_{rss}$ | Reverse Transfer Capacitance | | -- | 5 | 6.5 | pF |
| **Switching Characteristics** | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD}$ = 200 V, $I_D$ = 0.45 A, $R_G$ = 25 Ω (Note 3,4) | -- | 5 | 20 | ns |
| $t_r$ | Turn-On Rise Time | | -- | 20 | 50 | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | -- | 20 | 50 | ns |
| $t_f$ | Turn-Off Fall Time | | -- | 35 | 80 | ns |
| $Q_g$ | Total Gate Charge | $V_{DS}$ = 320 V, $I_D$ = 0.45 A, $V_{GS}$ = 10 V (Note 3,4) | -- | 5.8 | 7.5 | nC |
| $Q_{gs}$ | Gate-Source Charge | | -- | 0.53 | -- | nC |
| $Q_{gd}$ | Gate-Drain Charge | | -- | 3.22 | -- | nC |
| **Drain-Source Diode Characteristics and Maximum Ratings** | | | | | | |
| $I_S$ | Maximum Continuous Drain-Source Diode Forward Current | | -- | -- | 0.45 | A |
| $I_{SM}$ | Maximum Pulsed Drain-Source Diode Forward Current | | -- | -- | 1.8 | A |
| $V_{SD}$ | Drain-Source Diode Forward Voltage | $V_{GS}$ = 0 V, $I_S$ = 0.45 A | -- | -- | 1.5 | V |
| $t_{rr}$ | Reverse Recovery Time | $V_{GS}$ = 0 V, $I_S$ = 0.45 A, $dI_F$ / dt = 100 A/µs (Note 3) | -- | 86 | -- | ns |
| $Q_{rr}$ | Reverse Recovery Charge | | -- | 0.15 | -- | µC |

**Notes:**
1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $I_{SD} \leq$ 0.45A, di/dt $\leq$ 200A/µs, $V_{DD} \leq BV_{DSS}$, Starting $T_J$ = 25°C
3. Pulse Test : Pulse width $\leq$ 300µs, Duty cycle $\leq$ 2%
4. Essentially independent of operating temperature

## Typical Characteristics

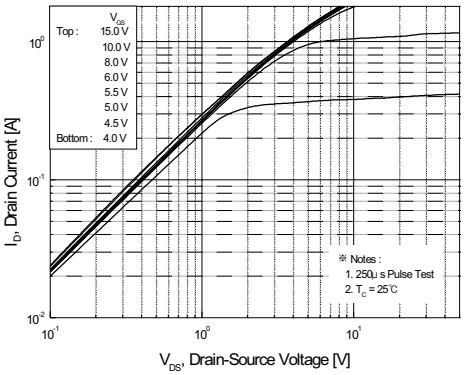



**Figure 1. On-Region Characteristics**

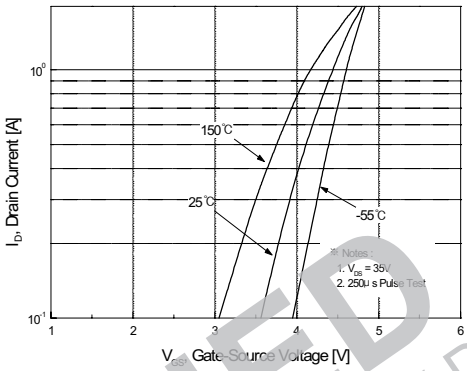



**Figure 2. Transfer Characteristics**

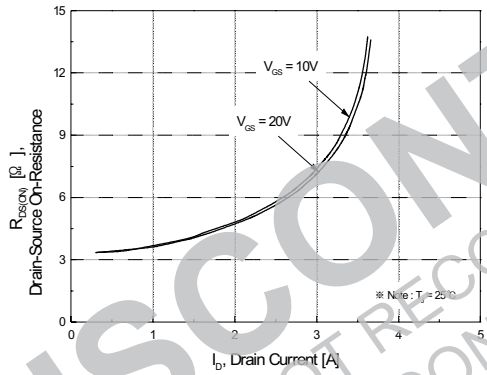



**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**

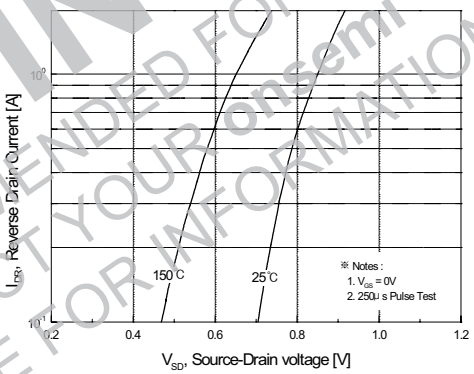



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

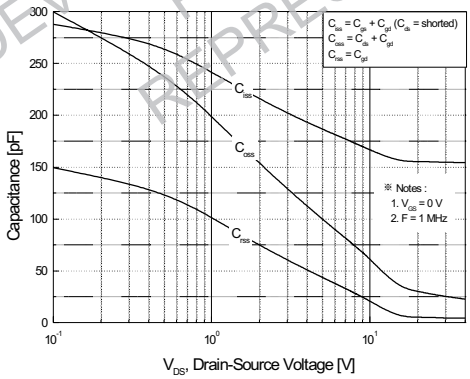



**Figure 5. Capacitance Characteristics**

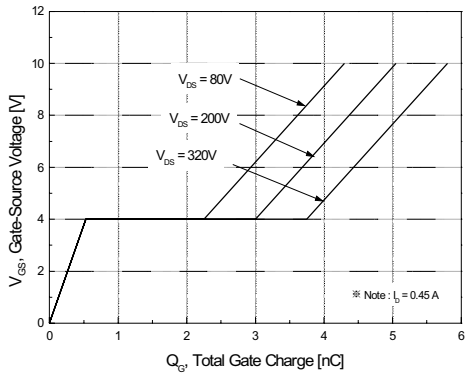



**Figure 6. Gate Charge Characteristics**

## Typical Characteristics (Continued)

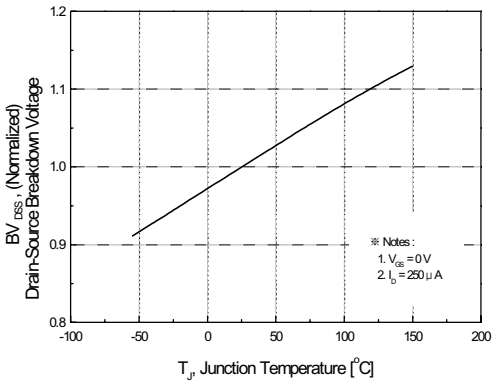



**Figure 7. Breakdown Voltage Variation vs. Temperature**

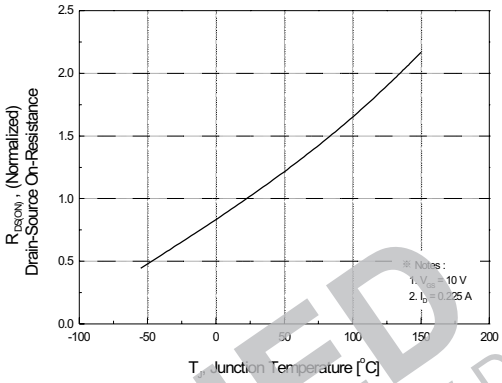



**Figure 8. On-Resistance Variation vs. Temperature**

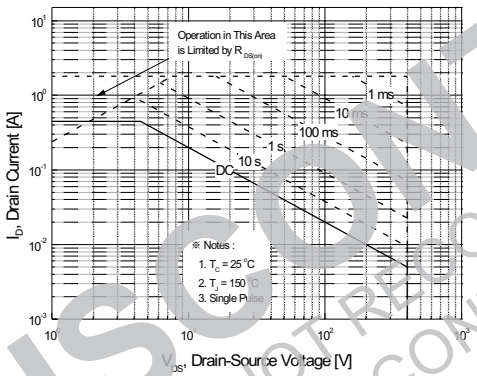



**Figure 9. Maximum Safe Operating Area**

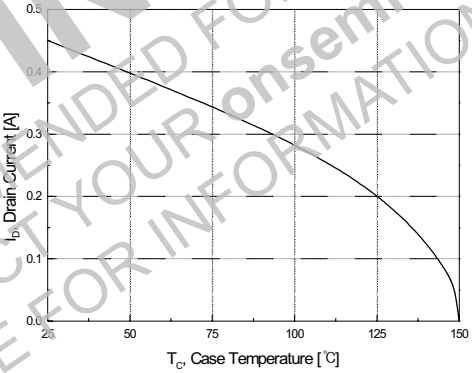



**Figure 10. Maximum Drain Current vs. Case Temperature**

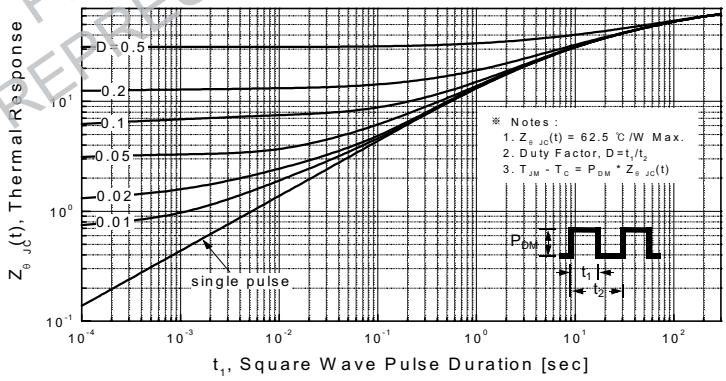
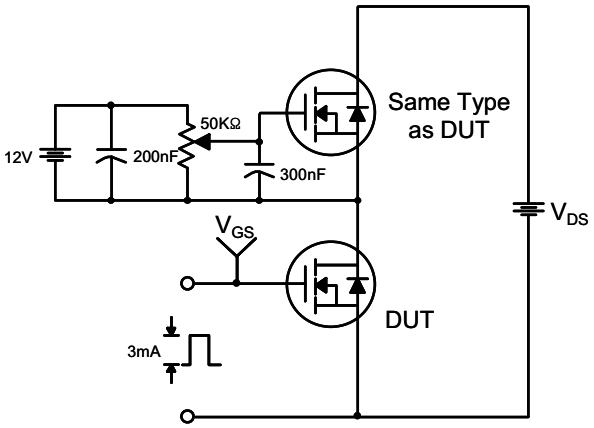
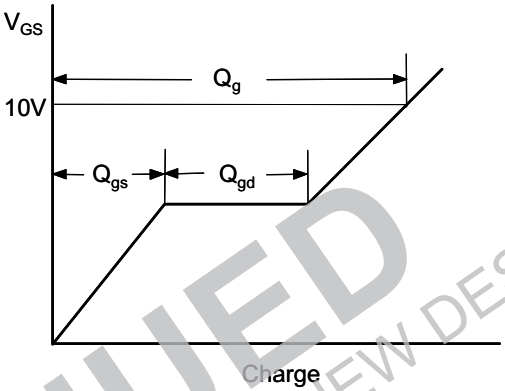


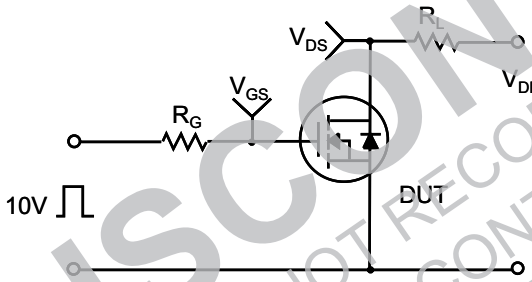

**Figure 11. Transient Thermal Response Curve**

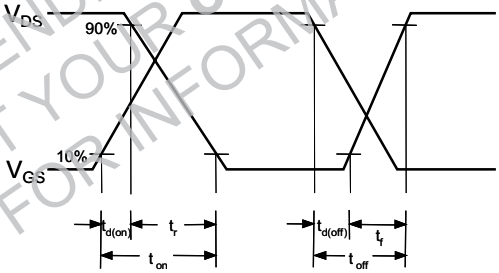
### Gate Charge Test Circuit & Waveform



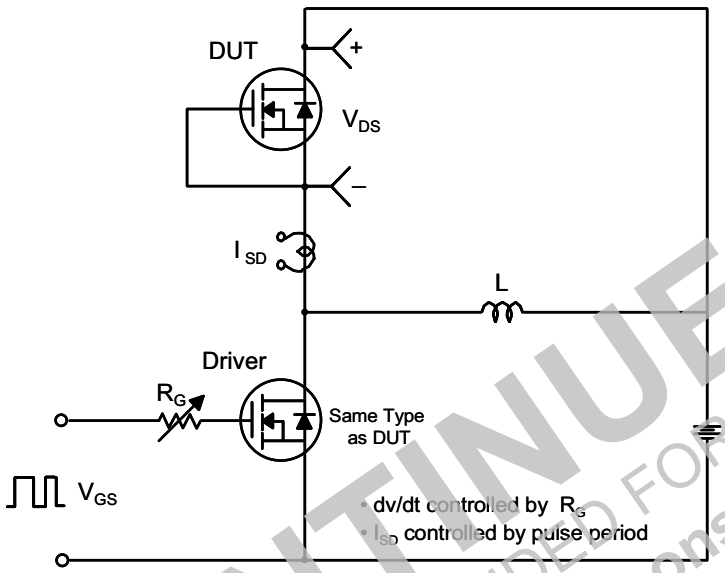



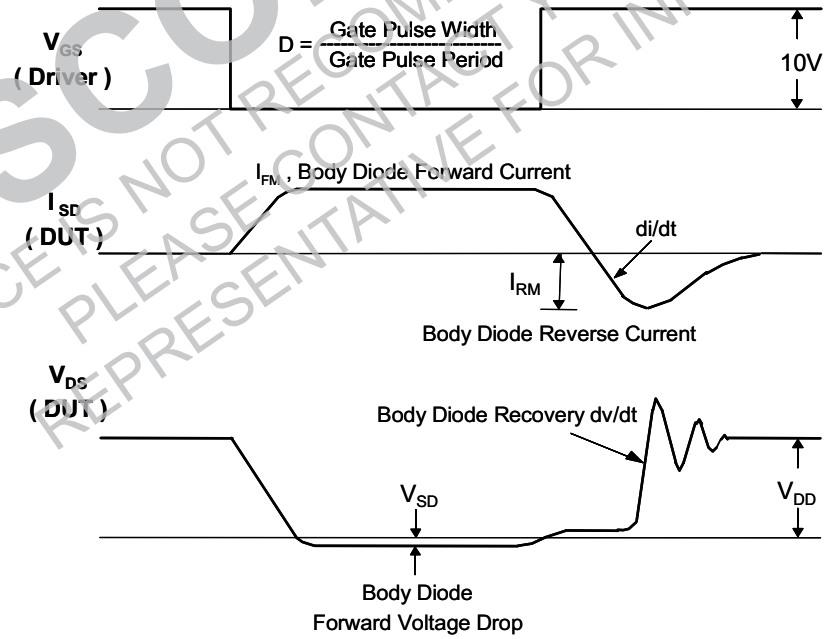

### Resistive Switching Test Circuit & Waveforms



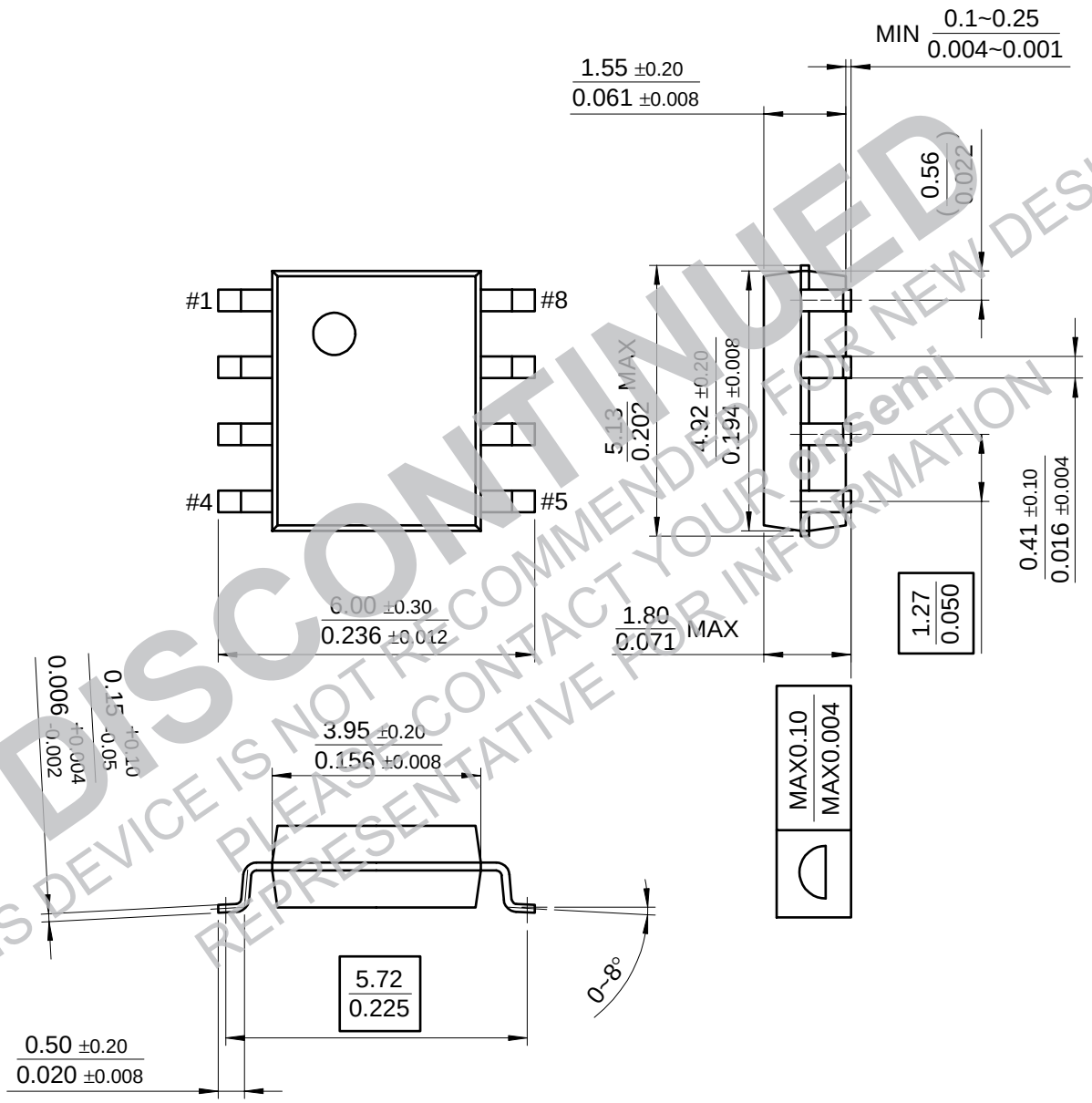
**Peak Diode Recovery dv/dt Test Circuit & Waveforms**



**Package Dimensions**

# 8SOP



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